

HSF

NOTES:

Current Rating:5.0A AMP
Contact Resistance:10milliohm Max
Withstand Voltage:1000V AC/Minute
Insulation Resistance:1000Megohm Min
Operation Temperature:-25℃ to +85℃

Housing Material:LCP+30%GF(UL94V-0)
Contact Material:Copper alloy
Contact plating:Au/Sn over Ni Plating

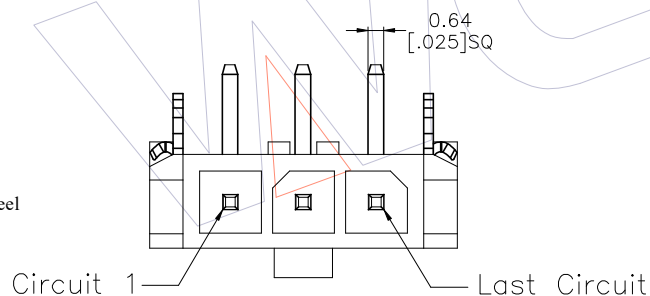
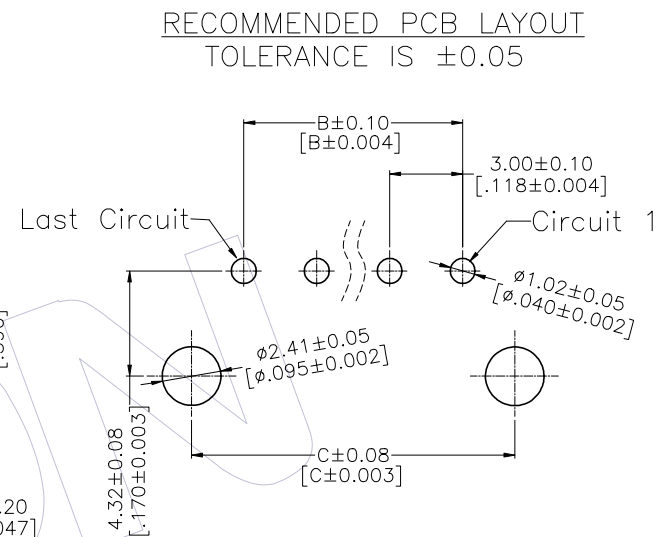
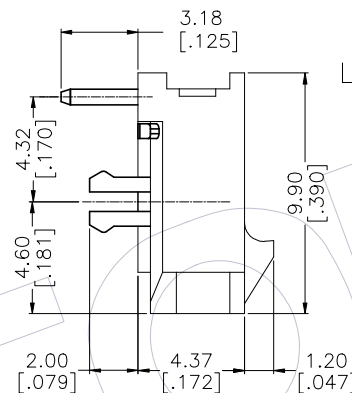
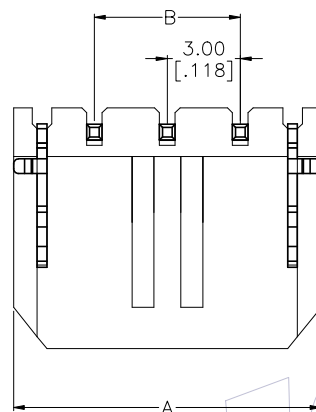
Ordering Information

WF3001-1 WR XX B X 2

Terminal shape:
WR:Wafer 90°DIP

NO.of Pins
02~12Pin

Packing:
0=PE Bag
T=Tube
A=Tray
R=Tape&Reel



Circuit	A	B	C
02	9.65[0.380]	3.00[0.118]	7.30[0.287]
03	12.65[0.498]	6.00[0.236]	10.30[0.405]
04	15.65[0.616]	9.00[0.355]	13.30[0.524]
05	18.65[0.735]	12.00[0.473]	16.30[0.642]
06	21.65[0.853]	15.00[0.591]	19.30[0.760]
07	24.65[0.971]	18.00[0.709]	22.30[0.878]
08	27.65[1.089]	21.00[0.827]	25.30[0.996]
09	30.65[1.207]	24.00[0.945]	28.30[1.114]
10	33.65[1.325]	27.00[1.063]	31.30[1.232]
11	36.65[1.443]	30.00[1.181]	34.30[1.350]
12	39.65[1.561]	33.00[1.299]	37.30[1.469]

				OPERATION		DRAW FZY	DATE 2012.05.02	SCALE	1:1	PART NO. WF3001-1WRXXBX2	WCON Http: www.wcon.com WCON—Dongguan Tel: +86 769 85358920 Fax: +86 769 85358915 E-mail: sales@wcon.com WCON—Kunshan Tel: +86 512 57468408 Fax: +86 512 57468468 E-mail: sales@wcon.com
				X.X	±0.40			UNIT	mm inch		
A1	2012.05.03	料号由WF3001-1WRHXXBX2变更为WF3001-1WRXXBX2	Atomy	X.XX	±0.25	CHECK	DATE	SIZE	A4	3.0 Wafer Single Row 90°DIP With Clip	
A0	2011.12.20	NEW	-	X.XXX	±0.15	APPROVE	DATE	SHEET	1/1	Customer NO.	
REV	DATE	MODIFICATION DESCRIPTION	CHANGE	Angle	± 3'			PROJ.			
				DIM	TOL						